



## **Cyber-Physical Production Systems Integrated into Industry 4.0 and Industry 5.0**

Guest Editors:

**Dr. Fotios K. Konstantinidis**

**Dr. Antonio Padovano**

**Dr. Dimitrios Chrysostomou**

**Prof. Dr. Antonios Gasteratos**

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### **Message from the Guest Editors**

Due to industrial automation, the integration of Cyber-Physical Production Systems (CPPS) with Industry 4.0 and Industry 5.0 has emerged as a transformative paradigm. Industry 4.0 represents the fourth industrial revolution, characterized by the fusion of digital technologies, data-driven decision making, and the seamless interaction between physical and virtual components, while Industry 5.0 represents the reintroduction of sustainability, human-centricity, and resilience within manufacturing. The concept of Cyber-Physical Production Systems lies at the heart of innovation, which seamlessly integrate the physical processes of manufacturing with advanced digital technologies. This integration not only enhances efficiency and productivity, but also introduces new frontiers for innovation and customization in industrial processes. This Special Issue explores the fundamental principles and implications of incorporating CPPS into the broader frameworks of Industry 4.0 and Industry 5.0, highlighting the synergies that drive industrial advancement.

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**Prof. Dr. Giulio Nicola Cerullo**

Dipartimento di Fisica,  
Politecnico di Milano, Piazza L.  
da Vinci 32, 20133 Milano, Italy

## Message from the Editor-in-Chief

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Applied Sciences Editorial Office  
MDPI, St. Alban-Anlage 66  
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